



Creative Materials, Inc.  
141 Middlesex Road  
Tyngsboro, MA 01879

T 978.649.4700  
F 978.649.2040

## 116-19

### LOW TEMPERATURE CURING CONDUCTIVE INK

**DESCRIPTION:** 116-19 is a carbon filled, polyester-based, electrically conductive ink, and coating suitable for application by stamping, screen printing, dipping and syringe dispensing. This product features excellent adhesion to Kapton, Mylar, glass and a variety of other surfaces. 116-19 is formulated to provide good conductivity when cured at low temperatures. Unlike conventional conductive materials, this product is very resistant to flexing and creasing. Some applications for 116-19 include, but are not limited to, emi/rfi shielding of polyimide flexible circuits, polymer thick film circuitry, membrane switches, and anode coatings for tantalum capacitors.

#### TYPICAL CURED PROPERTIES:

Consistency	Smooth Paste
Filler	Carbon
Crease Resistance	Excellent
Volume Resistivity (ohm-cm) (70°C)	0.125
Sheet Resistivity (ohm/sq/mil) (70°C)	50.0(Max)
Solderable	No
Hydrolytic Stability	Excellent
Useful Temperature Range	-55 to +200°C
Thermal Stability	Good to 325°C

**SUGGESTED HANDLING & CURING:** 116-19 is ready to use as supplied. Further thinning may be accomplished by adding small amounts of CMI Thinner #113-12. Prior to using, be certain to resuspend filler. Best properties, for most applications, result when cured for several minutes at 125°C to 150°C. Good properties are obtained on a variety of substrates by dry and curing for 15 minutes at 70°C. End user is advised to experimentally determine temperature and time best suited for individual applications.

**STORAGE:** Shelf Life: 6 months at 25°C; or 9 months at 5°C; or 12 months at -10°C.

**SAFETY & HANDLING:** Use with adequate ventilation. Keep away from sparks and open flames. Avoid prolonged contact with skin and breathing of vapors. Wash with soap and water to remove from skin.

*All technical information is based on data obtained by CMI personnel and is believed to be reliable. No warranty is either expressed or implied with respect to results or possible infringements on patents.*

REVISION DATE: 3/11/96 REVISION: A